

C1805C183J5RACTM

Aliases (C1805C183J5RAC7025) SMD Comm X7R, Ceramic, 0.018 uF, 5%, 50 VDC, X7R, SMD, MLCC, Temperature Stable, Class II, 1805, 2.9 mm



General Information	
Series	SMD Comm X7R
Style	SMD Chip
Description	SMD, MLCC, Temperature Stable, Class II
Features	Temperature Stable, Class II
RoHS	Yes
Termination	Tin
Marking	Yes
AEC-Q200	No
Typical Component Weight	41 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	1805
L	4.5mm +/-0.5mm
W	1.27mm +/-0.38mm
Т	0.9mm +/-0.10mm
S	2.9mm MIN
В	0.6mm +/-0.35mm

S	2.9mm MIN
В	0.6mm +/-0.35mm
Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape

4000

Packaging Quantity

Specifications	
Capacitance	0.018 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	5%
Voltage DC	50 VDC
Dielectric Withstanding Voltage	125 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	2.5% 1 kHz 1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	55.5556 GOhms

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